

- **Low Insertion Loss**
- **Excellent Selectivity**
- **Hermetic 13.3 X 6.5 mm Surface-mount Case**
- **Single-ended Input and Output**
- **Complies with Directive 2002/95/EC (RoHS)**

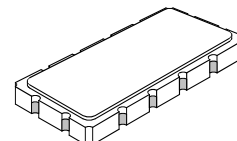
#### Absolute Maximum Ratings



Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage Between any 2 Terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260°C for 30 s	

**PX1004-1**

**82.2 MHz  
SAW Filter**



**SM13365-12**

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	$f_C$	1	82.20			MHz
Passband Insertion Loss at $f_C$ 3 dB Passband Amplitude Ripple over $f_C \pm 15$ kHz Group Delay Variation over $f_C \pm 17$ kHz	IL	1, 2		3.0	5.5	dB
	$BW_3$		$\pm 25$	$\pm 42$		kHz
					1.0	dB <sub>P-P</sub>
	GDV				6.0	$\mu$ s <sub>P-P</sub>
Third-Order Intermod. for -20 dBm tones at $f_C \pm 100$ & 200 kHz					-95	dBm
Rejection $f_C \pm 100$ kHz $f_C - 1500$ kHz to $f_C - 1600$ kHz Ultimate		1, 2, 3	11	16		dB
			65			
				65		
Operating Temperature Range	$T_A$	1	-20		+70	°C
Impedance Matching to 50 $\Omega$ unbalanced	External L-C					
Case Style	SM13365-12 13.3 X 6.5 mm Nominal Footprint					
Lid Symbolization (YY=year, WW=week) See note 4	RFM PX1004-1 YYWW					

#### Electrical Connections

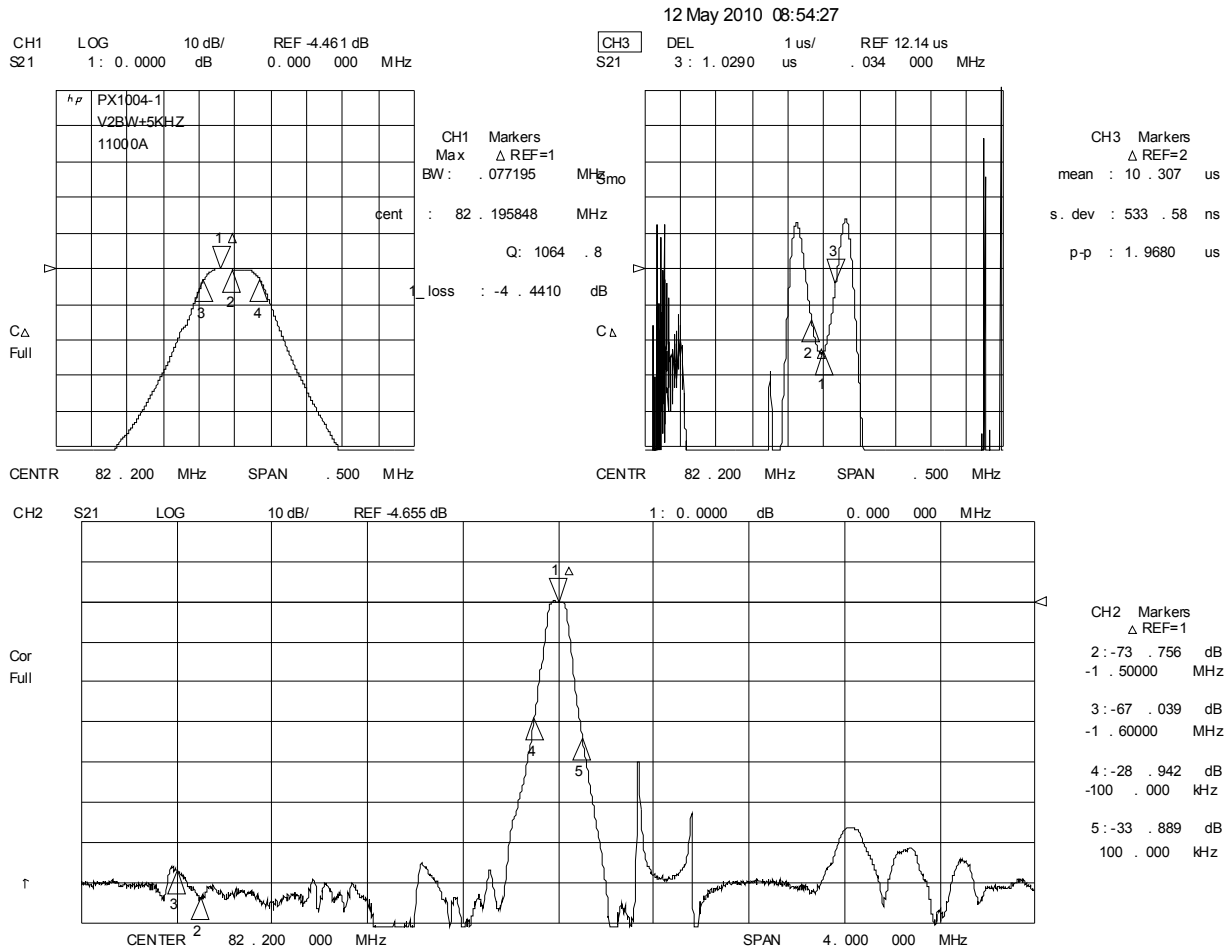
Connection	Terminals
Port 1 Hot	2
Port 1 Gnd Return	3
Port 2 Hot	8
Port 2 Gnd Return	9
Case Ground	All Others

#### NOTES:

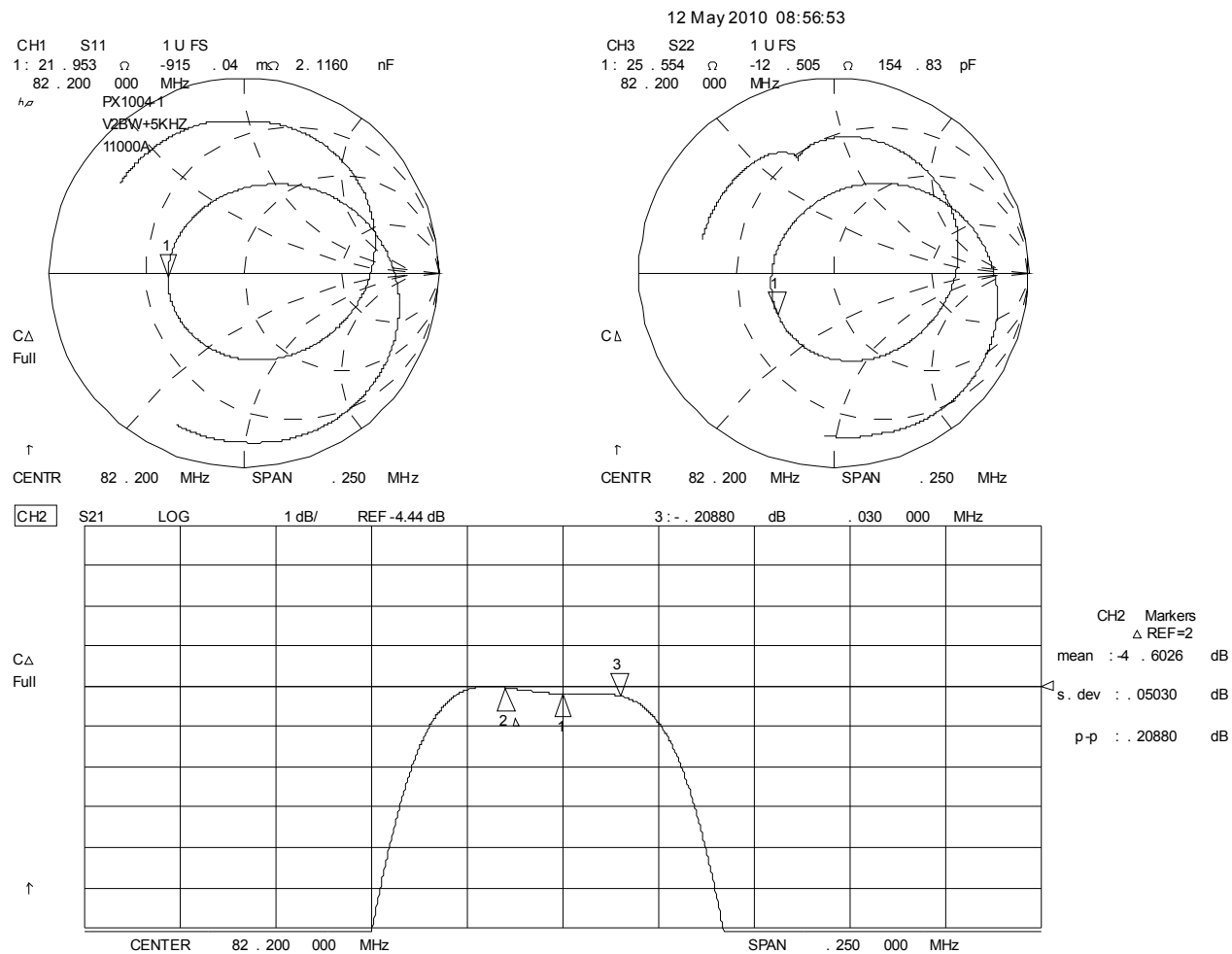
1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency,  $f_C$ .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
9. Electrostatic Sensitive Device. Observe precautions for handling.



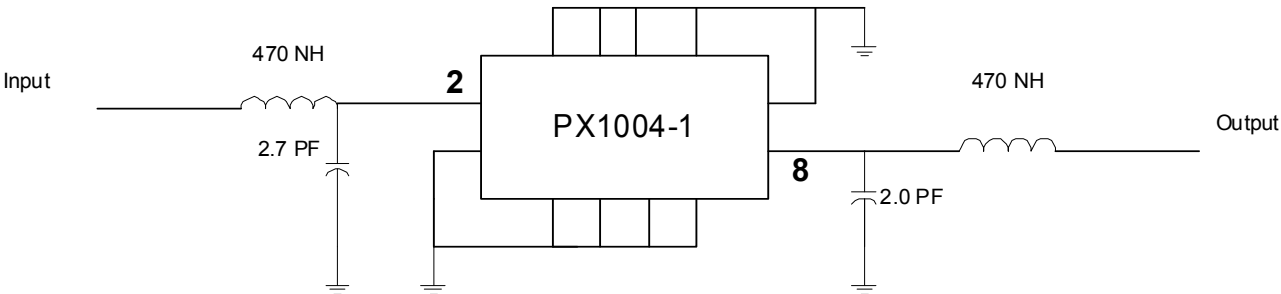
# Amplitude and Group Delay Plots



# Input/Output Impedance and Passband Amplitude Plots

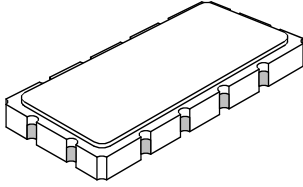


## Filter Test Circuit



# SM13365-12 Ceramic 12-Terminal Surface-Mount Case

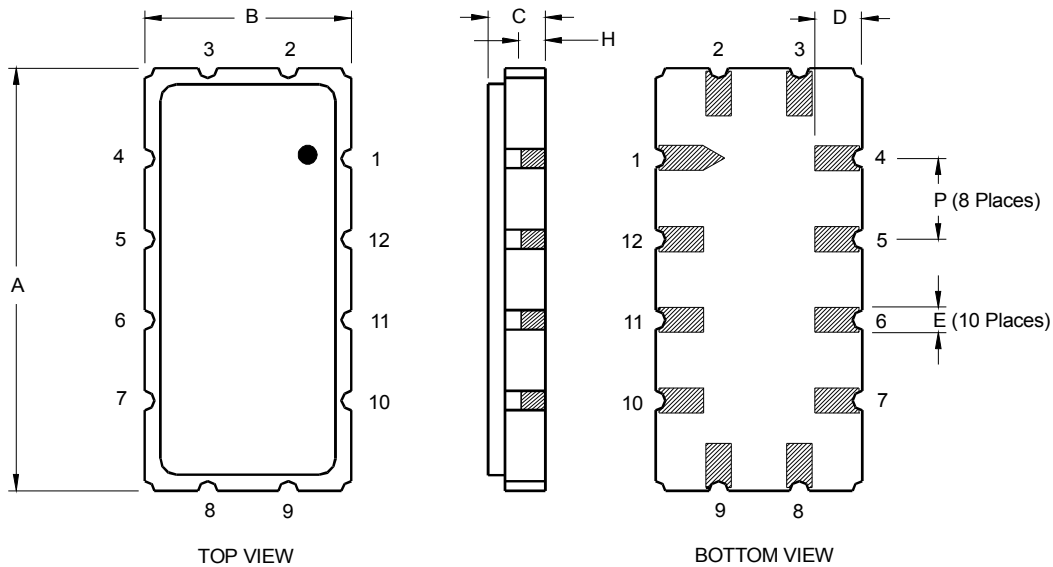
## 13.3 x 6.5 mm Nominal Footprint



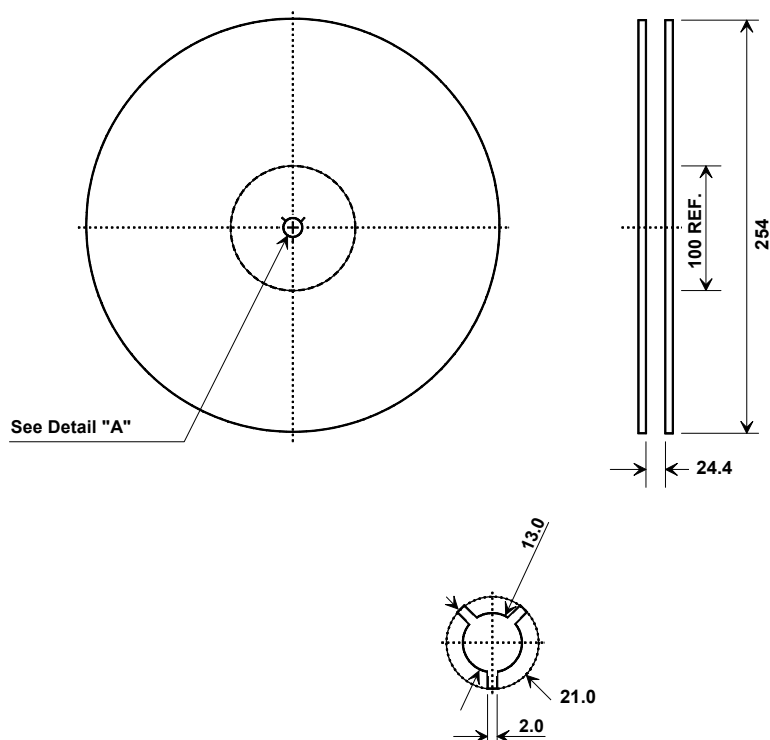
Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	13.08	13.31	13.60	0.515	0.524	0.535
B	6.27	6.50	6.80	0.247	0.256	0.268
C		1.91	2.00		0.075	0.079
D		1.50			0.059	
E		0.79			0.031	
H		1.0			0.039	
P		2.54			0.100	

Materials	
Solder Pad Plating	0.3 to 1.0 $\mu\text{m}$ Gold over 1.27 to 8.89 $\mu\text{m}$ Nickel
Lid Plating	2.0 to 3.0 $\mu\text{m}$ Nickel
Body	$\text{Al}_2\text{O}_3$ Ceramic
Pb Free	

Electrical Connections		
Connection		Terminals
Port 1	Input	2
	Return	3
Port 2	Output	8
	Return	9
Ground		All others
Single-ended Operation		Return is ground



## Tape and Reel Specifications



Quantity Per Reel
1000

## COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	7.0 mm
Bo	13.8 mm
Ko	2.0 mm
Pitch	12.0 mm
W	24.0 mm

